BALL GRID ARRAY

SERIES 540,579,582,587,599 • FOR 0,8mm GRID, 1mm GRID & .050" GRID • MALE PIN ADAPTERS AND FEMALE SOCKETS

- BGA adapter/socket systems are a reliable way to make BGAs pluggable. They may also be used as a high density board-to-board interconnect
- The BGA device for a 0,8mm or 1mm grid is soldered to a 9929 adapter (or a 7929 adapter is soldered to a PCB), then either one can be plugged into a 9953 (0.8mm grid) or 9928 (1mm grid) surface mount socket
- The BGA device for a .050" grid is soldered to a 8737/4048 adapter (or a 4098/4054 adapter is soldered to a PCB), then either one can be plugged into a 8214 surface mount socket
- Both socket and adapter have the same footprint as the BGA device
- Insertion force is .4N per pin for standard pins 7929/9929, 8737/4098. Tapered EZ-IN pins 4048/4054 reduce insertion force to only .08N, and are recommended for pin counts greater than 500
- Insulator material is FR-4 epoxy having a TCE to match the BGA device and circuit board
- For Electrical, Mechanical and Environmental Data, see page 141 for details



SERIES 599...429 BGA MOUNT TYPE #9929 .024 DIA. .047 .054 .123 .010 DIA.

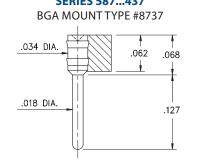
For 0,8mm & 1mm Grid Only SERIES 540...448

PCB MOUNT TYPE #7929 .024 DIA .018 THE. .010 DIA.

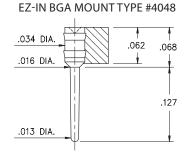
SERIES 579...429

For 0,8mm & 1mm Grid Only **SERIES 540...498**

STANDARD PCB MOUNT TYPE #4098



For .050" Grid Only **SERIES 540...454**

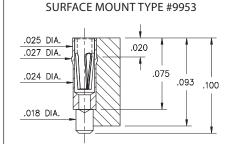


For .050" Grid Only **SERIES 599...453**

.022 DIA .034 DIA .091 .062 .018 DIA. .127

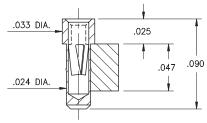
For .050" Grid Only

EZ-IN PCB MOUNT TYPE #4054 .034 DIA .091 .062 .018 DIA. .127 .016 DIA For .050" Grid Only



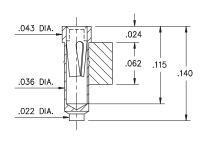
For 0,8mm Grid Only

SERIES 599...428 SURFACE MOUNT TYPE #9928



For 1mm Grid Only

SERIES 582...414 SURFACE MOUNT TYPE #8214



For .050" Grid Only

Visit www.mill-max.com/bga to configure a formal part number

SPECIFY PLATING CODE XX =		11 🔷	SPE
Sleeve (Pin)		10 μ" Au	Pin
Contact (Clip)		10 μ" Au	

ECIFY PLATING CODE XX = 10 🔷 10 μ" Au Plating

